



KUOK FOUNDATION BERHAD

STUDY AWARDS 2024 AT MALAYSIAN PRIVATE UNIVERSITIES



APPLY...

...if you are a **Malaysian student** applying for or currently pursuing **full time** first degree at the **following institutions** :-

- AIMST University, *Kedah*
- Asia Pacific University of Technology and Innovation, *Kuala Lumpur*
- HELP University, *Kuala Lumpur & Shah Alam*
- International Medical University, *Kuala Lumpur*
- INTI International University, *Nilai*
- Management and Science University, *Shah Alam*
- Monash University Malaysia, *Sunway*
- Multimedia University, *Cyberjaya & Melaka*
- SEGi University, *Kota Damansara*
- Southern University College, *Skudai*
- Sunway University, *Sunway*
- Swinburne University of Technology Sarawak Campus, *Kuching*
- Taylor's University, *Subang Jaya*
- Tunku Abdul Rahman University of Management and Technology, *Setapak*
- UCSI University, *Kuala Lumpur*
- Universiti Tunku Abdul Rahman, *Kampar & Sungai Long*
- University of Nottingham Malaysia Campus, *Semenyih*
- Xiamen University Malaysia, *Sepang*

Kuok Foundation Loan-Grant Awards

Value:
up to **RM50,000**
per year



Step 1

Submission of Online Application Form

Apply & submit online at
apply.kuokfoundation.org

Opening Date : 24 June 2024
Closing Date : 12 July 2024



Step 2

Submission of Printed Application Form

After applicants have submitted their application forms online, applicants **MUST ALSO** courier or send by hand the **PRINTED COPY OF THE APPLICATION FORMS** together with supporting documents to the Foundation's office.

Closing Date : 19 July 2024



- The awards are for **needy** students with good academic achievements, co-curriculum records and communication skills;
- For first degree courses undertaken and completed in Malaysia only;
- Courses must be accredited by MQA (*verify at www2.mqa.gov.my/mqr*)



Students studying diploma, off-campus, twinning programs, matriculation and foundation courses are **not eligible** to apply for the awards.



Only shortlisted candidates will be notified for interview.